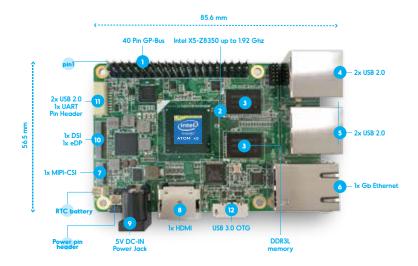
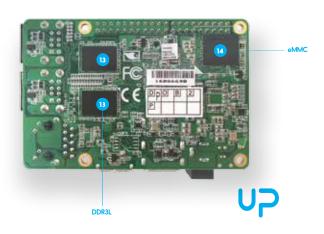


specification





UP is a credit card size board with the high performance and low power consumption features of the latest tablet technology: the Intel® Atom $^{\rm M}$ x5 Z8350 Processors (codename Cherry Trail) 64 bits up to 1.92GHz. The internal GPU is the new Intel Gen 8 HD 400 with 12 Execution Units up to 500MHz to deliver extremely high 3D graphic performance. UP is equipped with 1GB/2GB/4GB DDR3L RAM and 16GB/32GB/64GB eMMC .

UP has 40-pin General Purpose bus which provides the freedom to makers to build up their shield. There are more interfaces available, such as 4x port USB2.0 on connectors, 2x port USB2.0 + 1x UART on header, 1x USB 3.0 OTG. 1x Gbit Ethernet (full speed), 1x DSI/eDP port, 1x Camera (MIPI-CSI), 1x HDMI, RTC.

When it comes to security, UP has Intel security features needed for professional IoT applications such Intel AES New Instructions and Intel Identity Protection Technology.

It's UP to you to choose which operation system is best for your application. The CPU is supported by Android 5.0 Lollipop. Microsoft Windows $10\,$ and we support and enable Linux, through our UP Community.

UP has a standard industrial PC operating temperature range of $32\text{-}104^\circ\text{F}/0\text{-}60^\circ\text{C}$. which makes it flexible for many applications.

UP is perfect for professional makers.

- Applications -



Drones



Media Center



Education



Internet of Things



Robotics



Home Automation







HOMI



USE 2.0





Intel® Atom™ x5-Z8350 Processor (2M Cache, 1.44 GHz

Graphics

Intel® HD 400 Graphics ,12 EU GEN 8, up to 500MHz Support DX*11.1/12, Open GL*4.2, Open CL*1.2 OGL ES3.0, H.264, HEVC(decode), VP8

Video & Audio

Camera interface

CSI (4 Mega pixel)

USB 2.0

4x UB2.0 2x USB 2.0 pin header (10 pins in total)

RTC

Power

5V DC-in @ 3A 5.5/2.1mm jack

Dimensions

3.37" x 2.22" / 85.60 mm × 56.5 mm

Operating humidity
10%~80%RH non-condensing









—US■3.0









Memory 1GB / 2GB / 4GB DDR3L-1600

Storage Capacity 16GB eMMC / 32 GB / 64 GB eMMC

Display interface

Ethernet

x Gb Ethernet (full speed) RJ-45

USB 3.0

1x UB3.0 OTG

Expansion

40 pin General Purpose bus, supported by Altera Max V. ADC 8-bit@188ksos

Compatible Operating system

Microsoft Windows 10 full version, Windows IoT Core

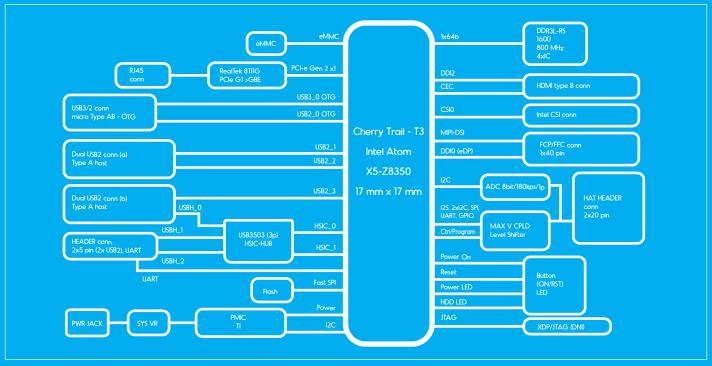
Linux (ubilinux, Ubuntu, Yocto) • Android Lollipop • Brillo

Operating Tempature

32-140°F / 0~60°C

Certificate

CE/FCC Class A, RoHS complaint Microsoft Azure certified



UP - Pinout



UP-CHT01-01-16-001 UP-CHT01-02-16-001 UP-CHT01-02-32-001

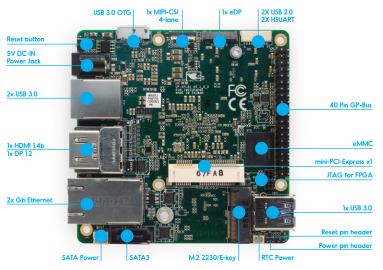
1GB RAM+16GB eMMC 2GB RAM+16GB eMMC 2GB RAM+32GB eMMC UP-CHT01-04-32-001 UP-CHT01-04-64-001 4GB RAM+32GB eMMC 4GB RAM+64GB eMMC Optional accessories

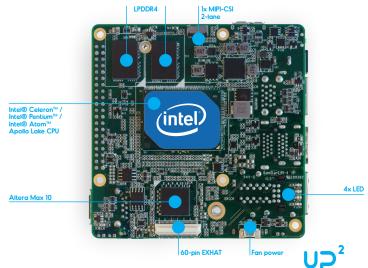
Heatsink/RTC battery Power adapter USB3.0 OTG cable HDMI cable



specification

The World's Fastest x86 Maker Board





UP² (UP Squared) is world's fastest maker board $\,$ with the high performance and low power consumption features of Intel® Celeron $^{\text{TM}}$, Pentium $^{\text{TM}}$ and Atom $^{\text{TM}}$ Processors (codename Apollo Lake).

The internal GPU is the new Intel Gen 9 HD with 12 / 18 Execution Units, supporting 4K Codec Decode and Encode for HEVC⁴, H.264 and VP8. Thanks to the Vector Units Image Processing Unit and Precision Timing Management to synchronize CPU with I/O, improved determinism (cache QoS, Intel Virtualization Technology), all the graphic processing is effortless to UP² (UP Squared).

UP² (UP Squared) comes with 2GB/4GB/8GB LPDDR4 and 32GB/64GB/128GB eMMC . A 40-pin GP-bus provides the freedom for makers to build up their module. Additionally, there is a 60-pin EXHAT for embedded applications. This allows for the exploration of more possibilities. The expansion capabilities of UP² (UP Squared) goes much further than this. Native mini-PCI-e, M.2 2230 and SATA3 are all built in on the board. What more could one desire?

The board supports Windows 10, Windows IoT Core, Ubilinux, Ubuntu, Yocto and Android Marshmallow . It's really UP to you to decide which operating system is best for your application. Now, all you need is an UP^2 (UP Squared) to begin your project!

- Applications -



Drones



Media Center



Education



Internet of Things



Robotics



Home Automation







HOMI







SOC

Intel® Celeron™ N3350 (up to 2.4 GHz) Intel® Pentium™ N4200 (up to 2.5 GHz) Intel® Atom™ E3940 (up to 1.8Ghz)

Intel® Gen 9 HD, supporting 4K Codec Decode and Encode for HEVC4, H.264, VP8

Video & Audio

HDMI 1.4b x1 4K @ 30 hz + DP 1.2 1x 4K @ 60 hz 12S audio port

Camera interface

CSI 2-lane + CSI 4-lane

Display interface

5V DC-in @ 4A-6A

Operating humidity
10%~80%RH non-condensing

Operating Tempature

32-140°F / 0~60°C

Altera MAX 10 FPGA

2KLE --Celeron/ Pentium 4KLE -- ATOM



шш















Memory 2GB (single channel) LPDDR4 4GB/8GB (dual channel) LPDDR4)

Storage Capacity 32 GB / 64 GB / 128 GB eMMC

3x UB3.0 (Type A) + 1x USB 3.0 OTG (Micro B)
2x USB2.0+2 X UART (Tx/Rx) debug port (pin header)

Ethernet

2x Gb Ethernet (full speed) RJ-45

RTC

Expansion

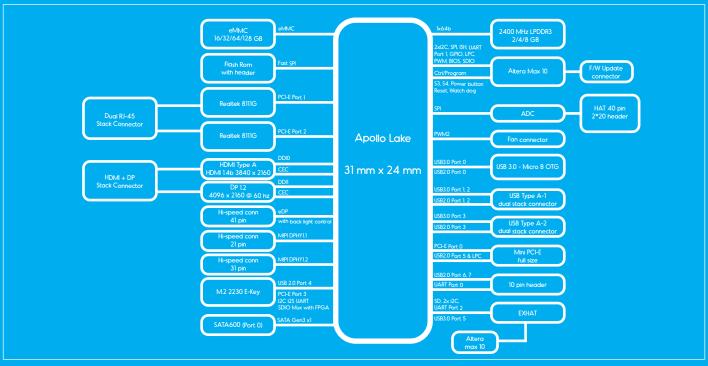
40 pin General Purpose bus 60 pin EXHAT

Compatible Operating system

Microsoft Windows 10 (full), Windows IOT Core, Linux (ubilinux, Ubuntu, Yocto), Android Marshmallow

Dimensions

Certificate



UP - Pinout

2 4 6 8	10 12 14 16	18 20 22 24	26 28 30 32	34 36 38 40
1 3 5 7	9 11 13 15	17 19 21 23	25 27 29 3]	33 35 37 39
① 3V3	② 5V	3 GPIO0/ I2C1_SDA	4 5∨	⑤ GPIO1/ I2C1_SCL
Ground	7 GPIO2/ ADC_in1	8 GPIO15/ UART_TXD	Ground	⊕ GPIO16/ UART_RXD
1) GPIO3/ UART_RTS/ SPI_2_FS1*/ ADC_in2	12 GPIO17/ I2S_BCLK/ SPI_2_FS0*	¹³ GPIO4/ ADC_in3		¹⁵ GPIO5/ ADC_in4
6 GPIO18	17 3V3	® GPIO19	[™] GPIO6/ SPI_1_TXD	20 Ground
② GPIO7/ SPI_1_RXD	22 GPIO20	33 GPIO8/ SPI_1_CLK	☑ GPIO21/ SPI_1_FS0	25 Ground
∞ GPIO22/ SPI_1_FS1	27 GPIO9/ I2C0_SDA	28 GPIO23/ I2C0_SCL	29 GPIO10	30 Ground
3) GPIO11	32 GPIO24/ PWM0	33 GPIO12/ PWM1	₃₄ Ground	35 GPIO13/ I2S_WS_SYNC/ SPI_2_RXD*
36 GPIO25/ UART_CTS/ SPI_2_FS2*	⋾ GPIO14	38 GPIO26/ I2S_SDI/ SPI_2_TXD*	39 Ground	

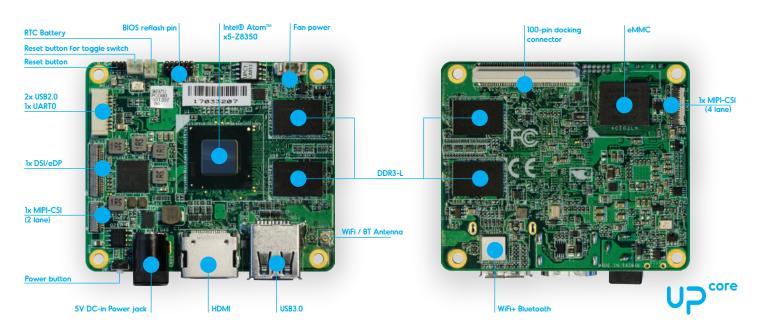
UP-APLC2-A10-0232 UP-APLC2-A10-0432 UP-APLP4-A10-0432

Intel® Celeron $^{\text{\tiny TM}}$ N3350 - 2 GB + 32 GB eMMC Intel® Celeron $^{\text{TM}}$ N3350 - 4 GB + 32 GB eMMC Intel® Pentium™ N4200 - 4 GB + 32 GB eMMC UP-APLP4-A10-0864 UP-APLA4-A10-0432

Intel® Pentium $^{\text{TM}}$ N4200 - 8 GB + 64 GB eMMC Intel® Atom $^{\text{TM}}$ E3940 - 4 GB + 32 GB eMMC



specification



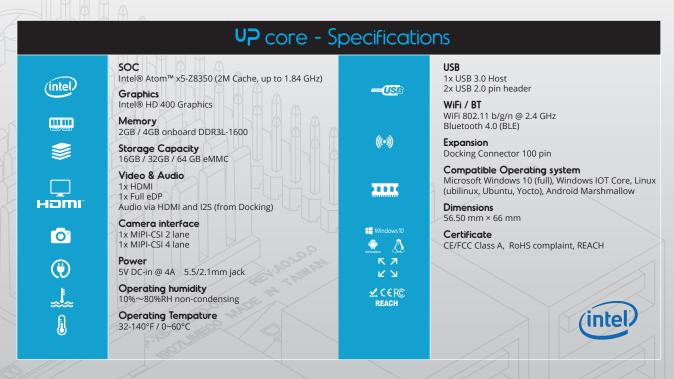
UP Core is a miniature board with the high performance and low power consumption features of the latest tablet technology: the Intel® $Atom^{IM}$ x5 Z8350 Processors (codename Cherry Trail) 64 bits up to 1.92GHz. The internal GPU is the new Intel Gen 8 HD 400 with 12 Execution Units up to 500MHz to deliver extremely high 3D graphic performance.

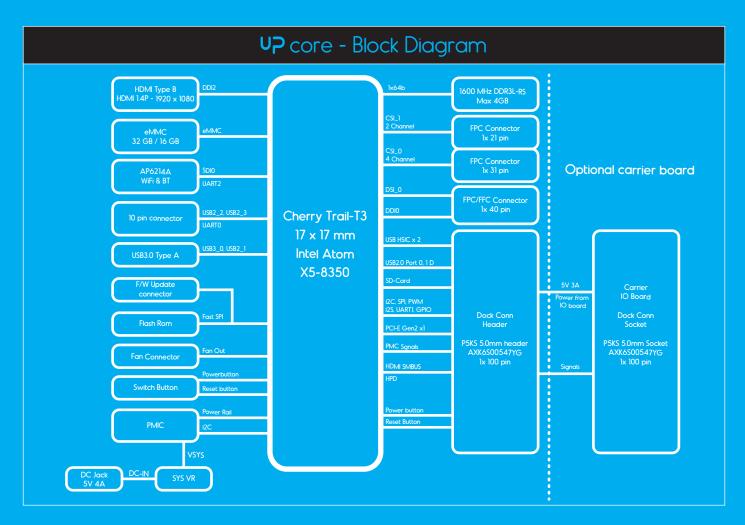
UP Core is equipped with 1GB/2GB/4GB DDR3L RAM and 16GB/32GB/64GB eMMC. With 100-pin docking connector, UP Core provides the freedom to makers to build up their carrier board. There are more interfaces available, such as 2x port USB2.0 + 1x UART on header, 1x USB 3.0 host, WiFi, Bluetooth 1x DSI/eDP port, 2x Camera (MIPI-CSI), 1x HMDI, RTC.

When it comes to security, UP Core has Intel security features needed for professional IoT applications such Intel AES New Instructions and Intel IdentityProtection Technology.

It's UP to you to choose which operation system is best for your application. The CPU is supported by Android 6.Marshmallow, Microsoft Windows 10 and we support and enable Linux, through our UP Community.

UP Core has a standard industrial PC operating temperature range of 32-140° F / 0-60°C, which makes it flexible for many applications.





UP core - Pin out

1) 5V	② Ground	4) RESERVE	PCIE_RX0_DP	I2C1_SOC_SCL
2 5V	22 DDI2_DDC_CLK			62 SD3_WP
3 5V	²³ GPIO7/HAT_SPI2_MOSI	43 Ground	PCIE_RX0_DN	83 Ground
4 5V	24 DDI2_DDC_DAT	44 ISH_GPIO9	64 USB2_P0_DP	⁸⁴ SD3_CLK
5 5V	25 GPIO8/SPI_MISO	45 GPIO18/I2S2_CLK	65 Ground	65 CPLD DOUT/ISH_I2C1_DATA
⊌ 5V	²⁶ HDMI_D	← GPIO25/PWM0	66 USB2_P0_DN	86 SD3_SD0
7 5V	27 GPIO9/SPI_CLK		Ø PCIE_REFCLK0_DP	67 ISH_I2C1_CLK
8 5V	28 HDMI_R	← GPIO13/PWM1 ← FIOR OF THE PROPERTY OF	68 Ground	88 SD3_SD1
• Ground	29 GPIO22/SPI_CS0N			89 Ground
¹⁰ Ground	30 DDI2_TYPE_C_HPD	50 Ground	₱ USB_OTG_R_ID	∞ SD3_SD2
n PMU_RSTBTN_N	³⁾ GPIO23/SPI_CS1N	⑤ GPIO28/I2S2_DATAOUT	n Ground	9 RESERVE
12 UART1_RTS	32 ISH_GPIO0	52 USB_HSIC_1_DATA	72 Ground	2 SD3_SD3
13 PMU_PWRBTN_N	33 Ground	53 Ground	73 I2C0_SOC_SDA	® RESERVE
14 UART1_CTS	³⁴ CPLD CLEAR/ISH_GPIO1	USB_HSIC_1_STROBE ■	[™] SD3_CD	[™] Ground
15 PMU_SLP_SOIX_N	35 RESERVE	55 PCIE_TX0_DP	75 I2C0_SOC_SCL	95 RESERVE
¹⁶ GPIO16/UART1_TX	36 ISH_GPIO2	56 Ground	[™] SD3_CMD	
PCIE_CLKREQ0	37 RESERVE	57 PCIE_TX0_DN	77 Ground	97 RESERVE
® GPIO17/UART1_RX	35 ISH_GPIO3	58 USB_HSIC_2_DATA	⁷⁰ SD3_1P8_EN	68 CPLD_RST/GPIO_SUS8
19 PMC_SUSCLK0	39 RESERVE	59 Ground	79 I2C1_SOC_SDA	
²⁰ Ground	40 ISH_GPIO4	■ USB_HSIC_2_STROBE	SD3_PWREN	© CPLD_STROBE/GPIO_SUS9

Part number : Coming soon